ROHM LDO IC Evaluation Kit

• Abstract
This evaluation board manual describes the usage of ROHM’s LDO IC evaluation kit (EVK) called BD7xxL2EFJ/FP/FP3-CE2 EVK. This document provides guidelines to quickly setup the hardware for IC performance evaluation.

• Description of Supported ICs
This EVK is an LDO IC evaluation board. The application of the board is to let a user evaluate the performance of the BD7xxL2xx-CE2 LDO. The function of the board is to linearly regulate a wide input DC voltage range to a fixed output DC voltage level. There are two voltage levels (3.3V and 5V) and 3 types of packages HTSOP-J8, TO252-3 and SOT223-4F. The LDO IC features low consumption current of 6μA, integrated overcurrent and thermal shutdown protection, low saturation voltage by using PMOS output transistor and high output voltage accuracy of ±2%.

• EVK Key Specifications (Across Model Versions)
  ▪ Absolute maximum input voltage .............45V
  ▪ Output current capability..........................200mA
  ▪ Output voltage.....................................3.3V or 5V

• EVK Applications
This EVK is
  ▪ only to be used as device under test for research and development and the purpose of IC evaluation.
  ▪ only to be operated by trained professionals.
  ▪ not intended to be assembled into other products.

SOT223-4F
TO252-3
HTSOP-J8
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1. Introduction
This EVK is an LDO IC evaluation board. The application of the board is to let a user evaluate the performance of the BD7xxL2EFJ/FP/FP3-CE2 LDO. The purpose of the EVK is to allow the test and evaluation of the LDO IC in professional research and development environments. This document provides guidelines to quickly setup the hardware for fast and easy LDO IC performance evaluation. For further details about the LDO ICs and other ROHM products, please also consult the relevant product datasheets and general information at http://www.rohm.com.

1.1 Operating instructions
A block diagram of the EVK application is depicted in Figure 1. In order to evaluate the board apply input voltage, connect the DC load and measure the output voltage of the LDO. Note: when connecting laboratory equipment and other peripherals do not use cables with length more than 3 meters due to EMC compliance.

Figure 1: EVK operating block diagram

1.2 Electrical Parameters / EVK Model Overview
This LDO EVK has 6 different model variants. The main difference between the variants is the package of the LDO and output voltage level. Table 1 gives an overview of the different IC features and the according naming of the EVK.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Value</th>
<th>Unit</th>
<th>EVK Model</th>
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</thead>
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<tr>
<td>Input</td>
<td>Current</td>
<td>Iin</td>
<td>Min</td>
<td>Typ</td>
</tr>
<tr>
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<td>Voltage</td>
<td>Vin</td>
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<td>4.9</td>
<td>5.0</td>
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<td>TO252-3</td>
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<td>SOT223-4F</td>
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<td></td>
</tr>
</tbody>
</table>

Table 1: EVK Model Variants
2. Hardware Description

The schematic of the EVK is shown in Figure 2 and the Bill-of-Materials (BOM) is summarized in Table 2. Besides the LDO IC, the main part of the EVK is the input supply decoupling capacitor and output filtering capacitor.

2.1 Schematic

![Figure 2: EVK Schematic](image)

2.1 Bill of Materials

<table>
<thead>
<tr>
<th>No.</th>
<th>Value</th>
<th>Description</th>
<th>Size</th>
<th>Part number</th>
<th>Manufacturer</th>
<th>EVK Model</th>
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<td>Low Iq LDO</td>
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<td>ROHM</td>
<td>BD733L2EFJ</td>
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<td></td>
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<td>BD750L2EFJ-CE2</td>
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<td>BD733L2FP</td>
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<td></td>
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<td>BD733L2FP3</td>
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<td>CIN</td>
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<td>TDK</td>
<td>all</td>
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<td>CGB3B1X5R1A475M055AC</td>
<td>TDK</td>
<td>all</td>
</tr>
</tbody>
</table>

Table 2: Bill of Materials
3. Safety Instructions

3.1 Warnings

- This product should be operated in a well ventilated environment and, if used inside a case, the case should not be covered.
- This product should be placed on a stable, flat, non-conductive surface in use and should not be contacted by conductive items.
- All peripherals used with the EVK should comply with relevant standards for the country of use and be marked accordingly to ensure that safety and performance requirements are met.
- Where peripherals are connected that do not include the cable or connector, the cable or connector used must offer adequate insulation and operation in order that the requirements of the relevant performance and safety are met.
- The connection of incompatible devices to the EVK may affect compliance or result in damage to the unit and invalidate the warranty.

3.2 Instructions for Safe Use

- Do not expose it to water, moisture or place on a conductive surface whilst in operation.
- Do not expose it to temperatures, which are out of the operational range specified for hardware and components populating the EVK.
- Take care whilst handling to avoid mechanical or electrical damage to the printed circuit board and components
- Avoid handling the printed circuit board while it is powered. Only handle by the edges to minimize the risk of electrostatic discharge damage.
Notes

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